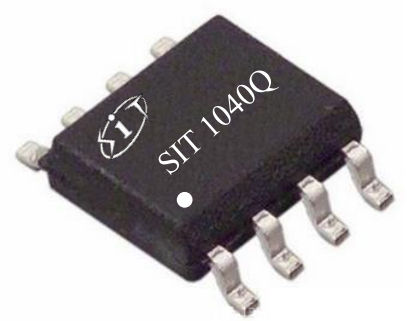
FEATURES

- Fully compatible with the ISO 11898 standard
- AEC-Q100 qualified
- Thermally protected
- Overcurrent protection function
- Transmit Data (TXD) dominant time-out function
- Very low-current standby mode with remote wake-up Capability via the bus: 5μA Typical
- Transceiver in unpowered state disengages from the bus (zero load)
- At least 110 nodes can be connected
- High speed (up to 1 MBaud)
- Very low Electro Magnetic Emission (EME)

PRODUCT OUTLINE



Provide Green and Environmentally Friendly Lead-free package

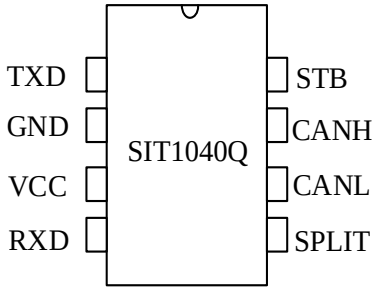
*Provide HVSON8 / DFN3*3-8，Small Outline， Leadless Package

DESCRIPTION

The SIT1040Q is the interface between the Controller Area Network (CAN) protocol controller and the physical bus. It is primarily intended for high speed applications, up to 1 MBaud, in passenger cars. The device provides differential transmit capability to the bus and differential receive capability to the CAN controller.

PARAMETER	SYMBOL	CONDITION	MIN.	MAX.	UNIT
Supply voltage	V_{cc}		4.75	5.25	V
Maximum transmission rate	$1/t_{bit}$	Non-return to zero code	1		Mbaud
CANH/CANL input or output voltage	V_{can}		-40	+40	V
Bus differential voltage	V_{diff}		1.5	3.0	V
Virtual junction temperature	T_j		-40	125	℃
ESD capability	Vesd	HBM	±8		kV

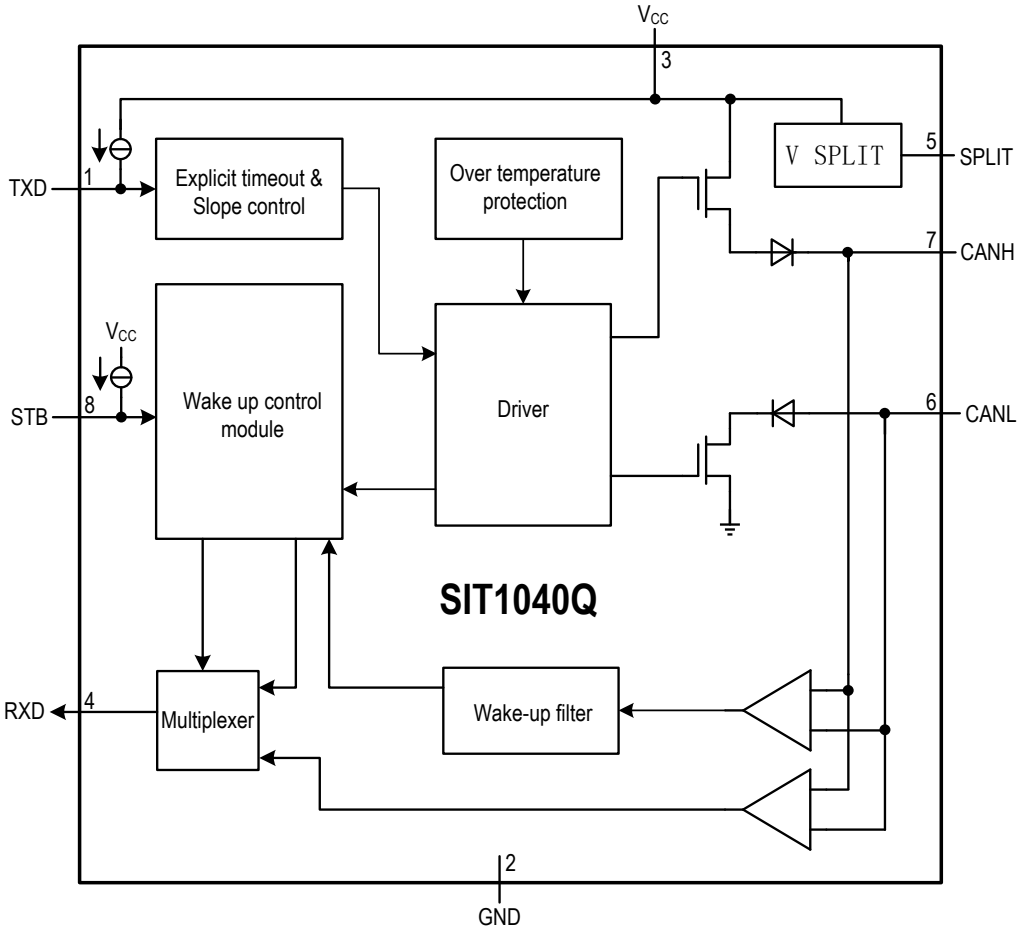
PIN CONFIGURATION



PINNING

PIN	SYMBOL	DESCRIPTION
1	TXD	transmit data input
2	GND	ground supply
3	VCC	supply voltage
4	RXD	receive data output; reads out datafrom the bus lines
5	SPLIT	common-mode stabilization output
6	CANL	LOW-level CAN bus line
7	CANH	HIGH-level CAN bus line
8	STB	standby mode control input

Note: For DFN3*3-8/HVSON8 package, the back pad is connected to the GND pin of the chip. For better heat dissipation, you can connect the pad on the back to the corresponding "ground" of the PCB board.



SIT1040Q internal block diagram

LIMITING VALUES

PARAMETER	SYMBOL	VALUE	UNIT
Supply voltage	V_{CC}	-0.3~+6	V
DC voltage on TXD/RXD/STB pins	TXD，RXD，STB	-0.3~VCC+0.3	V
Voltage range at any bus terminal (CANH, CANL, SPLIT)	CANL，CANH，SPLIT	-40~40	V
Storage temperature		-55~150	℃
Virtual junction temperature		-40~125	℃
Welding temperature range		300	℃

The maximum limit parameters means that exceeding these values may cause irreversible damage to the device. Under these conditions, it is not conducive to the normal opration of the device. The continuous operation of the device at the maximum allowable rating may affect the reliability of the device. The reference point for all voltages is ground.

DRIVER ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
CANH dominant output voltage	$V_{OH(D)}$	VI=0V, STB=0V, RL=60Ω, Fig.1, Fig.2	2.75	3.5	4.5	V
CANL dominant output voltage	$V_{OL(D)}$		0.5	1.5	2.25	V
Bus recessive output voltage	$V_{O(R)}$	VI=3V, STB=0V, RL=60Ω，Fig.1, Fig.2	2	2.5	3	V
Bus dominant differential output voltage	$V_{OD(D)}$	VI=0V, STB=0V，RL=60Ω，Fig.1, Fig.2	1.5		3	V
Bus recessive differential output voltage	$V_{OD(R)}$	VI=3V, STB=0V，Fig.1, Fig.2	-0.012		0.012	V
		VI=3V, STB=0V, NO LOAD	-0.5		0.05	V
Transmitter voltage symmetry	V_{TXsym}	$V_{TXsym}= V_{CANH} + V_{CANL}$	$0.9V_{CC}$		$1.1V_{CC}$	V
Common-mode output voltage	V_{OC}	STB=0V, Fig.8	2	2.5	3	V

Peak-to-peak Common-mode output voltage	$\triangle V_{OC}$			30		mV
Short-circuit output current	I_{OS}	CANH=-12V, CANL=open, Fig.11	-105	-40		mA
		CANH=12V, CANL=open, Fig.11		0.36	1	mA
		CANL=-12V, CANH=open, Fig.11	-1	0.5		mA
		CANL=12V, CANH=open, Fig.11		71	105	mA
Recessive output current	$I_{O(R)}$	-27V<CANH<32V 0<VCC<5.25V	-2.0		2.5	mA

（V_{CC}=5V±5% and Temp=T_{MIN}~T_{MAX} unless specified otherwise; typical in V_{CC}=+5V and Temp=25℃）

DRIVER SWITCHING CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Propagation delay time, low-to-high-level output	tPLH	STB=0V, Fig.4	25	90	150	ns
Propagation delay time, low-to-high-level output	tPHL		20	45	90	ns
Differential output signal rise time	tr			25		ns
Differential output signal fall time	tf			50		ns
Enable time from standby mode to dominant	t_{EN}	Fig.7			10	μs
Bus dominant time-out time	t_{dom}	Fig.10	300	450	700	μs
Bus wake-up filter time	t_{BUS}		0.7		5	μs

（V_{CC}=5V±5% and Temp=T_{MIN}~T_{MAX} unless specified otherwise; typical in V_{CC}=+5V and Temp=25℃）

RECEIVER ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Positive-going input threshold voltage	V_{IT+}	STB=0V, Fig.5		750	900	mV
Negative-going input threshold voltage	V_{IT-}		500	650		mV
Hysteresis voltage ($V_{IT+} - V_{IT-}$)	V_{HYS}		80	100		mV
High-level output voltage	V_{OH}	IO=-2mA, Fig.6	4	4.6		V
Low-level output voltage	V_{OL}	IO=2mA, Fig.6		0.2	0.4	V
Power-off bus input current	$I_{(OFF)}$	CANH or CANL=5V, Other pin=0V			5	μA
Input capacitance to ground, (CANH or CANL)	C_I			13		pF
Differential input capacitance	C_{ID}			5		pF
Input resistance, (CANH or CANL)	R_{IN}	TXD=3V, STB=0V	15	30	40	kΩ
Differential input resistance	R_{ID}		30		80	kΩ
Input resistance matching	RI_{match}	CANH=CANL	-3%		3%	
The range of commen-mode voltage	V_{COM}		-12		12	V

（V_{CC}=5V±5% and Temp=T_{MIN}~T_{MAX} unless specified otherwise; typical in V_{CC}=+5V and Temp＝25℃）

RECEIVER SWITCHING CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Propagation delay time,low-to-high-level output	tPLH	STB=0V or VCC, Fig.6	60	100	140	ns
Propagation delay time,low-to-high-level	tPHL		45	70	100	ns

output						
RXD signal rise time	tr			8		ns
RXD signal fall time	tf			8		ns

（V_{CC}=5V±5% and Temp=T_{MIN}~T_{MAX} unless specified otherwise; typical in V_{CC}=+5V and Temp＝25℃）

DEVICE SWITCHING CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Loop delay1, driver input to receiver output, Recessive to Dominant	Td(LOOP1)	STB=0V，Fig.9	90		190	ns
Loop delay 2, driver input to receiver output, Dominant to Recessive	Td(LOOP2)		90		190	ns

（V_{CC}=5V±5% and Temp=T_{MIN}~T_{MAX} unless specified otherwise; typical in V_{CC}=+5V and Temp＝25℃）

OVER TEMPERATURE PROTECTION

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Shutdown junction temperature	Tj(sd)			160		℃

TXD-PIN CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
HIGH-level input current	I_{IH}(TXD)	VI=VCC	-2		2	μA
LOW-level input current	I_{IL}(TXD)	VI=0	-50		-10	μA
When VCC=0V，current on TXD pin	I_O(off)	VCC=0V，TXD=5V			1	μA
HIGH-level input	V_{IH}		2		VCC+0.3	V

voltage						
LOW-level input voltage	V_{IL}		-0.3		0.8	V
Open voltage on TXD pin	TXD_O		H			logic

（V_{CC}=5V±5% and Temp=T_{MIN}~T_{MAX} unless specified otherwise; typical in V_{CC}=+5V and Temp＝25℃）

STB PIN CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
HIGH-level input voltage	V_{IH}		2.0		VCC+0.3	V
LOW-level input voltage	V_{IL}		-0.3		0.8	V
HIGH-level input current	I_{IH}	V_S=VCC		0		μA
LOW-level input current	I_{IL}	V_S=0V	-1	-3	-10	μA

COMMOM-MODE STABILIZATION OUTPUT

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Common-mode stabilization output voltage	V_O	-500uA<I_o<500uA	0.3V_{CC}		0.7V_{CC}	V
Leakage current	$I_{O(stb)}$	STB=2, -12V<V_O<12V	-5		5	μA

（V_{CC}=5V±5% and Temp=T_{MIN}~T_{MAX} unless specified otherwise; typical in V_{CC}=+5V and Temp＝25℃）

SUPPLY CURRENT

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Standby	I_{CC}	STB=VCC, V_I=VCC		5	12	μA
Dominant		V_I=0V, STB=0V, LOAD=60Ω		38	70	mA

Recessive		V_I=VCC, STB=0V, NO LOAD		3.6	10	mA

（V_{CC}=5V±5% and Temp=T_{MIN}~T_{MAX} unless specified otherwise; typical in V_{CC}=+5V and Temp＝25℃）

FUNCTION TABLE

Table1.CAN TRANSCEIVER TRUTH TABLE

V_{CC}	TXD(1)	STB(1)	CANH(1)	CANL(1)	BUS STATE	RXD(1)
4.5V~5.5V	L	L	H	L	Dominate	L
4.5V~5.5V	H or Open	L	0.5V_{CC}	0.5V_{CC}	Recessive	H
4.5V~5.5V	X	H or Open	GND	GND	Recessive	H
0<V_{CC}<4.5V	X	X	0V<V_{CANH}<V_{CC}	0V<V_{CANL}<V_{CC}	Recessive	X

（1）H=high level; L=low level; X=irrelevant

Table 2. RECEIVER FUNCTION TABLE

V_{ID}=CANH-CANL	RXD(1)	Bus State(1)
V_{ID}≥0.9V	L	Dominate
0.5< V_{ID}<0.9V	?	?
V_{ID}≤0.5V	H	Recessive
Open	H	Recessive

（1）H=high-level; L=low-level; ?=uncertain

TEST CIRCUIT

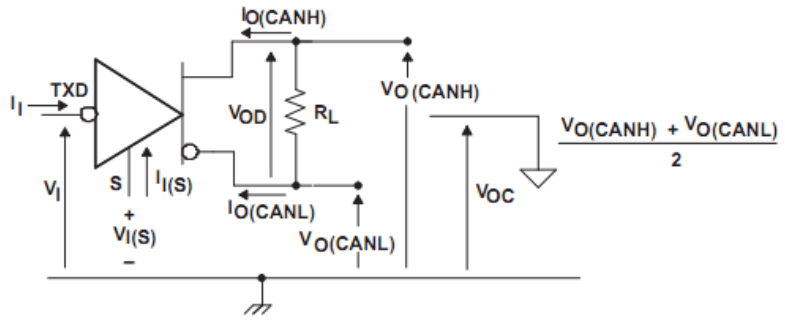


Fig.1 Driver Voltage, Current, and Test Definition

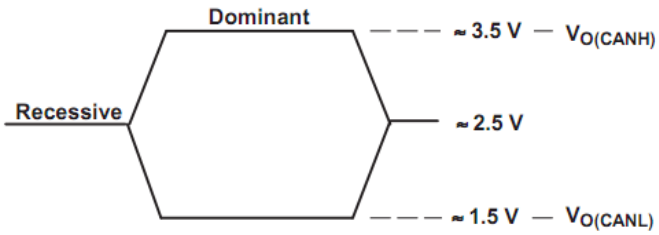


Fig.2 Bus Logic State Voltage Definition

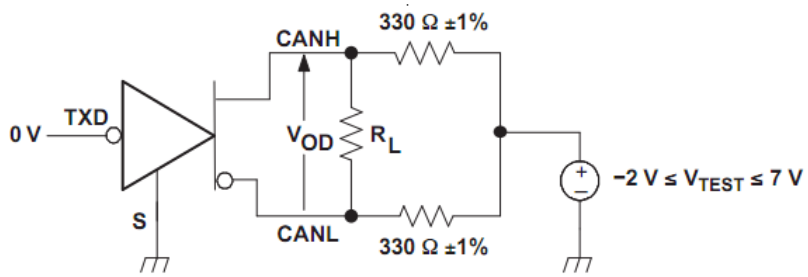


Fig.3 Driver V_{OD} Test Circuit

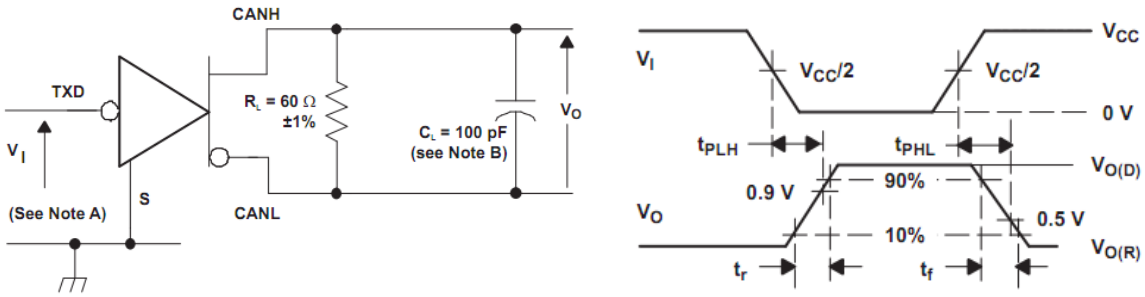


Fig.4 Driver Test Circuit and Waveform

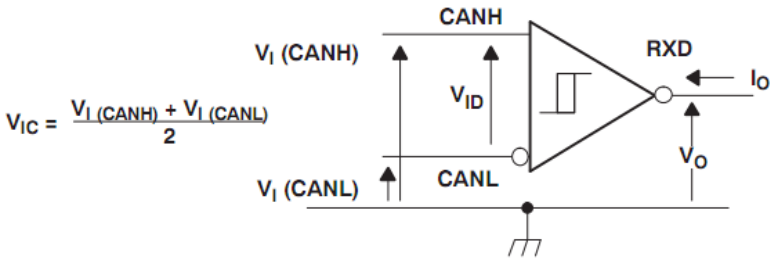
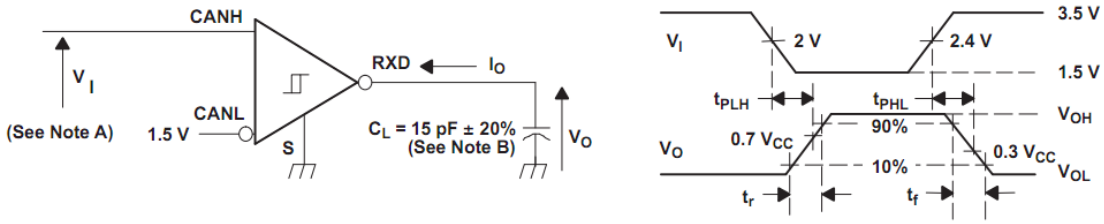


Fig.5 Receiver Voltage and Current Definition



A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 125 kHz, 50% duty cycle, t_r ≤ 6 ns, t_f ≤ 6ns, Z_O = 50 Ω.

B. C_L includes instrumentation and fixture capacitance within ±20%.

Fig.6 Receiver Test Circuit and Waveform

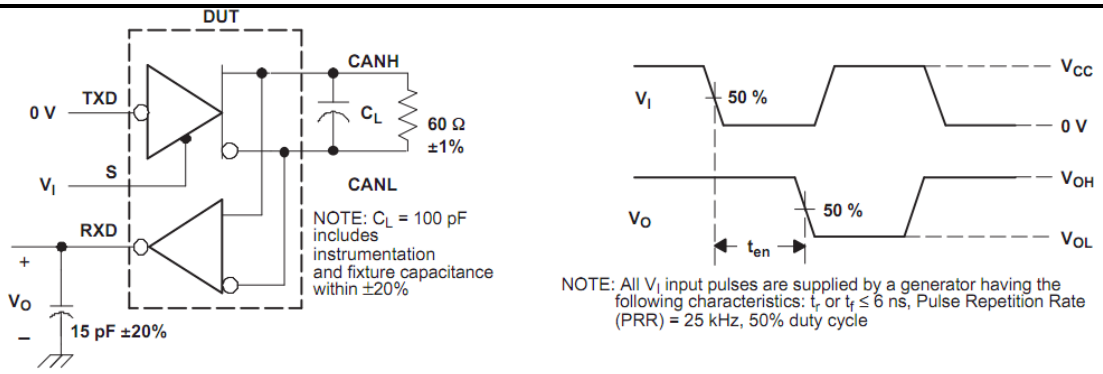
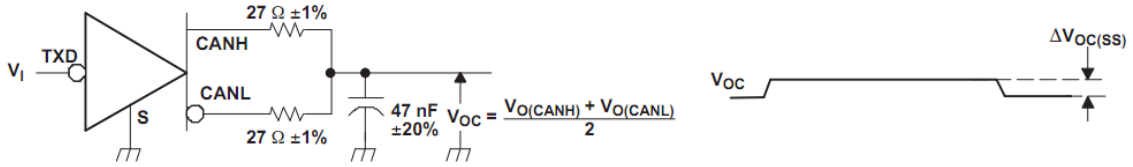


Fig.7 t_{EN} Test Circuit and Waveform



A. All VI input pulses are from 0 V to VCC and supplied by a generator having the following characteristics: tr or tf ≤ 6 ns. Pulse Repetition Rate (PRR) = 125 kHz, 50% duty cycle.

Fig.8 Peak-to-Peak Common Mode Output Voltage Test and Waveform

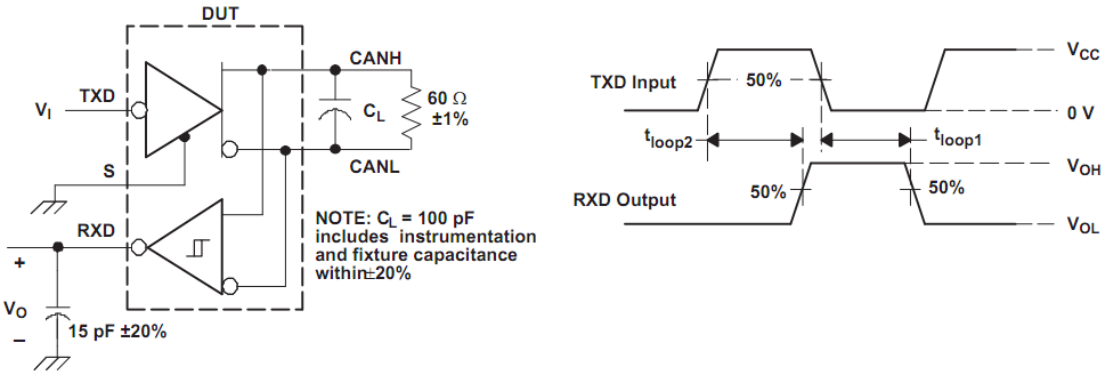


Fig.9 $t_{(LOOP)}$ Test Circuit and Waveform

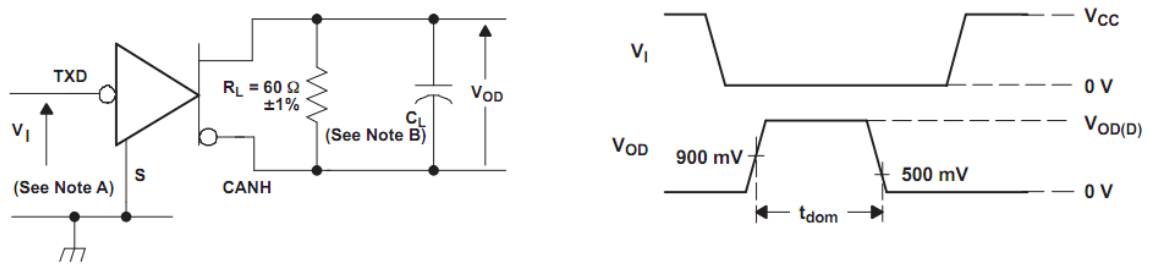


Fig.10 Dominant Time-Out Test Circuit and Waveform

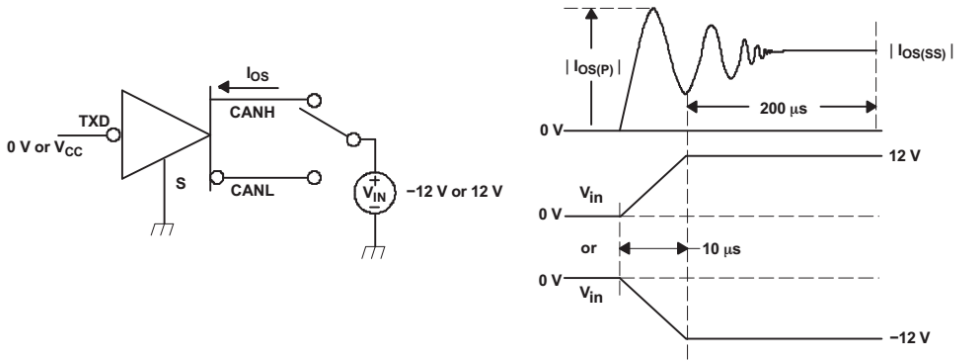


Fig.11 Driver Short-Circuit Current Test Circuit and Waveform

ADDIYIONAL DESCRIPTION

1 Sketch

The SIT1040Q is the interface between the Controller Area Network (CAN) protocol controller and the physical bus, and can be applied to the fields of trucks, buses, cars, industrial control etc. It is primarily intended for high speed applications, up to 1 MBaud, in passenger cars. The device provides differential transmit capability to the bus and differential receive capability to the CAN controller, and fully compatible with the ISO 11898 standard.

2 Current protection

A current-limiting circuit protects the transmitter output stage from damage caused by accidental short-circuit to either positive or negative supply voltage, although power dissipation increases during this fault condition.

3 Fail-safe features

Pin TXD provides a pull-up towards VCC in order to force a recessive level in case pin TXD is unsupplied.
Pin STB provides a pull-up towards VCC in order to force the transceiver into standby mode in case pin STB is unsupplied.
In the event that the VCC is lost, pins TXD, STB and RXD will become floating to prevent reverse supplying conditions via these pins.

4 Over temperature protection

The output drivers are protected against over-temperature conditions. If the virtual junction temperature exceeds the shutdown junction temperature Tj(sd), the output drivers will be disabled until the virtual junction temperature becomes lower than Tj(sd) and TXD becomes recessive again.
By including the TXD condition, the occurrence of output driver oscillation due to temperature drifts is avoided.

5 TXD dominant time-out function

A ‘TXD dominant time-out’ timer circuit prevents the bus lines from being driven to a permanent dominant state(blocking all network communication) if pin TXD is forced permanently LOW by a hardware and/or software application failure. The timer is triggered by a negative edge on pin TXD.
If the duration of the LOW level on pin TXD exceeds the internal timer value (tdom), the transmitter is disabled, driving the bus lines into a recessive state. The timer is reset by a positive edge on pin TXD.

6 Operating modes

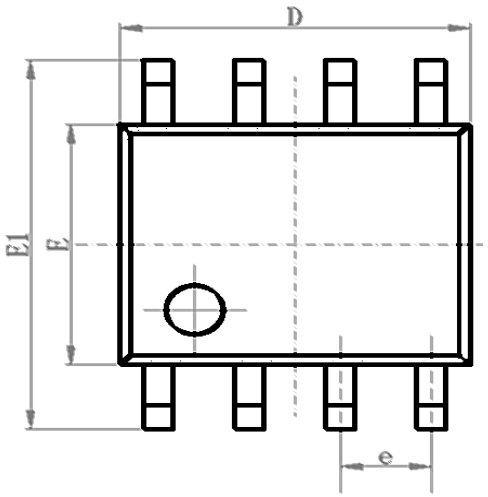
The SIT1040Q provides two modes of operation which are selectable via pin STB:
High-speed mode and standby mode.
High-speed mode is normal working mode, by connecting STB to ground to set the SIT1040Q to high-speed mode. In this mode the transceiver is able to transmit and receive data via the bus lines CANH and CANL. The differential receiver converts the analog data on the bus lines into digital data which is output to pin RXD via the multiplexer (MUX).

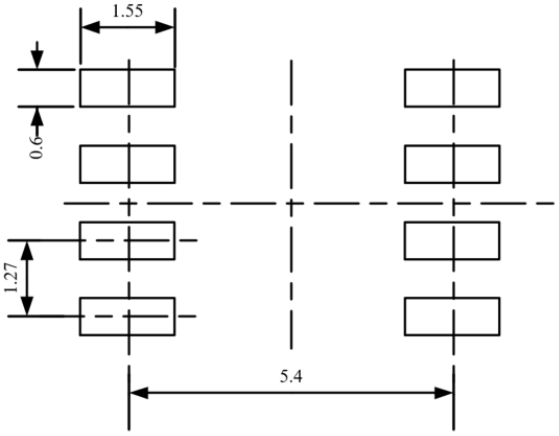
If a logic-high or open is applied to STB, the SIT1040Q enters a low-current standby mode. In this mode the transmitter and receiver are switched off, and the low-power differential receiver will monitor the bus lines. A HIGH level on pin STB activates this low-power receiver and the wake-up filter, and after tBUS the state of the CAN bus is reflected on pin RXD.

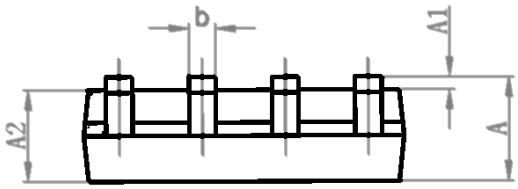
SOP8 DIMENSIONS

PACKAGE SIZE

SYMBOL	MIN./mm	TYP./mm	MAX./mm
A	1.40	-	1.80
A1	0.10	-	0.25
A2	1.30	1.40	1.50
b	0.38	-	0.51
D	4.80	4.90	5.00
E	3.80	3.90	4.00
E1	5.80	6.00	6.20
e		1.27BSC	
L	0.40	0.60	0.80
c	0.20	-	0.25
θ	0°	-	8°





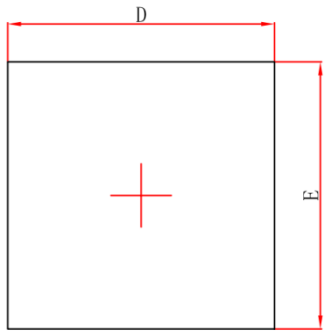


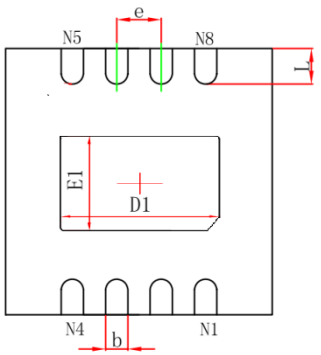
LAND PATTERN EXAMPLE (Unit: mm)

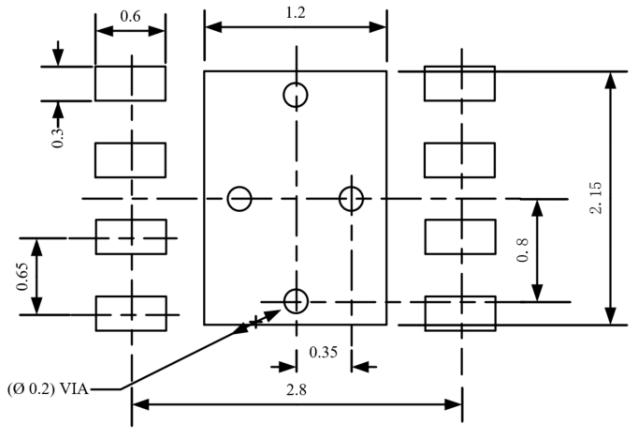
DFN3*3-8 /HVSON8 DIMENSIONS

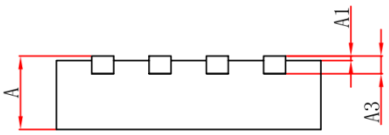
PACKAGE SIZE

SYMBOL	MIN./mm	TYP./mm	MAX./mm
A	0.70	0.75	0.80
A1	0	0.02	0.05
A3	0.203 REF		
D	2.90	3.00	3.10
E	2.90	3.00	3.10
D1	2.05	2.15	2.25
E1	1.10	1.20	1.30
b	0.25	0.30	0.35
e	0.65 TYP		
L	0.35	0.4	0.45









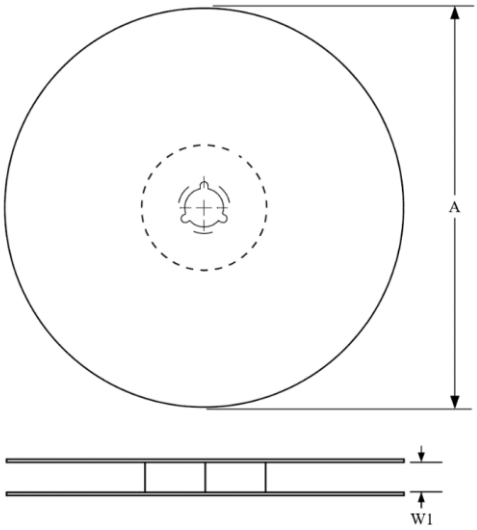
LAND PATTERN EXAMPLE (Unit: mm)

ORDERING INFORMATION

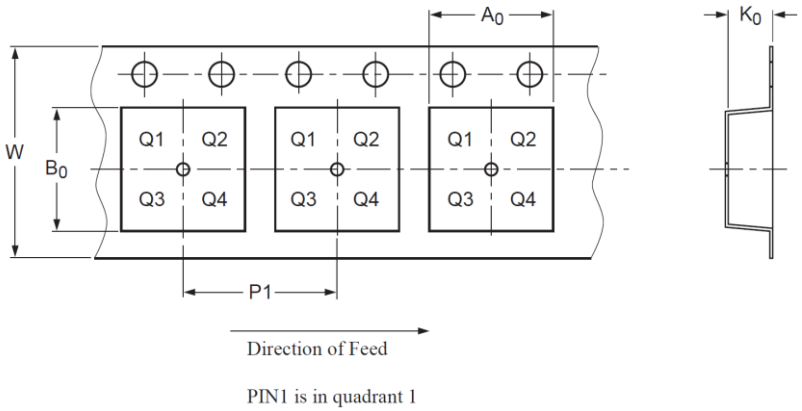
TYPE NUMBER	PACKAGE	PACKING
SIT1040QT	SOP8	Tape and reel
SIT1040QTK	HVSON8 / DFN3*3-8， Small shape, no leads, 8 terminals	Tape and reel

SOP8 tape packaging is 2500 pieces/disc. DFN tape packaging is 6000 pieces/disc.

TAPE AND REEL INFORMATION



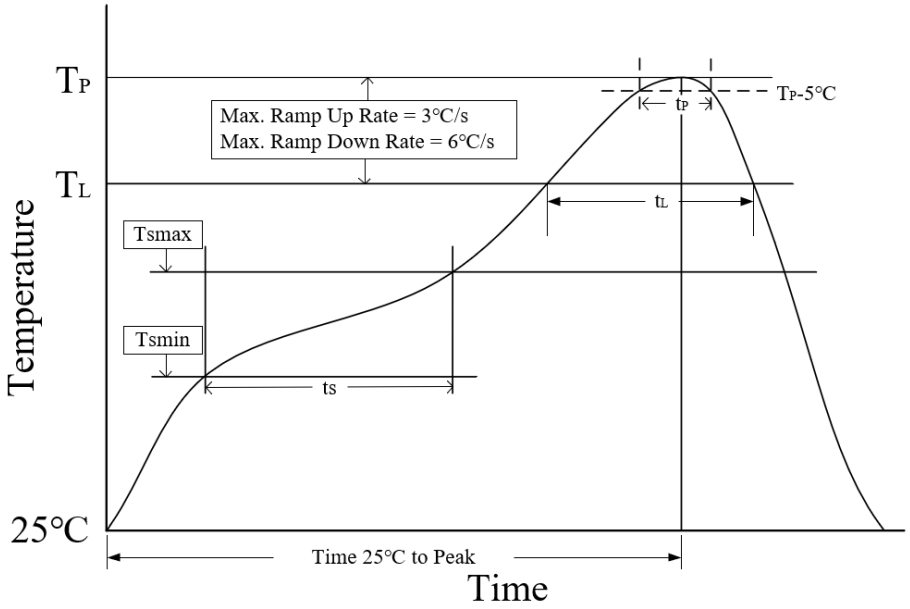
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers



PIN1 is in quadrant 1

Package Type	Reel Diameter A (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)
SOP8	330±1	12.4	6.60±0.1	5.30±0.10	1.90±0.1	8.00±0.1	12.00±0.1
DFN3*3-8	329±1	12.4	3.30±0.1	3.30±0.1	1.10±0.1	8.00±0.1	12.00±0.3

REFLOW SOLDERING



Parameter	Lead-free soldering conditions
Ave ramp up rate（T_L to T_P）	3 ℃/second max
Preheat time ts （T_{smin}=150 ℃ to T_{smax}=200 ℃）	60-120 seconds
Melting time t_L（T_L=217 ℃）	60-150 seconds
Peak temp T_P	260-265 ℃
5°C below peak temperature t_P	30 seconds
Ave cooling rate（T_P to T_L）	6 ℃/second max
Normal temperature 25℃ to peak temperature TP time	8 minutes max

Important statement

SIT reserves the right to change the above-mentioned information without prior notice.

REVISION HISTORY

Version number	Data sheet status	Revision time
V1.0	Initial version	2021.06
V1.1	Delete CANH, CANL transient voltage parameters； Modify drive propagation delay； Modify CANH, CANL differential input capacitance； Modify CANH, CANL differential input resistance； Add STB pin characteristics； Modify SOP8 package size； Modify DFN3*3-8 package size；	2022.02
V1.2	Modify the range of CANH output voltage (dominant) and CANL output voltage (dominant); Add chip pad information; Add tape information; Add reflow information; Add revision history;	2022.07